

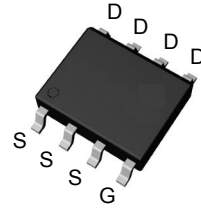
## Features

- 40V/12.5A,  
 $R_{DS(ON)} = 8.5m\Omega$  (Typ.) @  $V_{GS}=10V$   
 $R_{DS(ON)} = 10m\Omega$  (Typ.) @  $V_{GS}=4.5V$
- Reliable and Rugged
- Lead Free and Green Devices Available  
(RoHS Compliant)

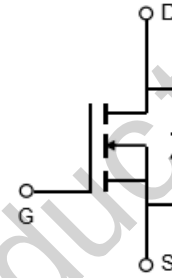
## Applications

- Power Management in Desktop Computer or DC/DC Converters.
- Power Load Switch.
- Notebook Battery Management.

## Pin Description



Top View of SOP-8



N-Channel MOSFET

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| Symbol                       | Parameter                              |                      | Rating     | Unit |
|------------------------------|----------------------------------------|----------------------|------------|------|
| Common Ratings               |                                        |                      |            |      |
| V <sub>DSS</sub>             | Drain-Source Voltage                   |                      | 40         | V    |
| V <sub>GSS</sub>             | Gate-Source Voltage                    |                      | ±20        |      |
| T <sub>J</sub>               | Maximum Junction Temperature           |                      | 150        | °C   |
| T <sub>STG</sub>             | Storage Temperature Range              |                      | -55 to 150 |      |
| I <sub>S</sub>               | Diode Continuous Forward Current       | T <sub>A</sub> =25°C | 2          | A    |
| I <sub>D</sub>               | Continuous Drain Current               | T <sub>A</sub> =25°C | 12.5       | A    |
|                              |                                        | T <sub>A</sub> =70°C | 8.4        |      |
| I <sub>DM</sub> <sup>a</sup> | Pulsed Drain Current                   | T <sub>A</sub> =25°C | 30         |      |
| P <sub>D</sub>               | Maximum Power Dissipation              | T <sub>A</sub> =25°C | 2.08       | W    |
|                              |                                        | T <sub>A</sub> =70°C | 1.3        |      |
| R <sub>θJA</sub>             | Thermal Resistance-Junction to Ambient | t ≤ 10s              | 30         | °C/W |
|                              |                                        | Steady State         | 60         |      |
| R <sub>θJL</sub>             | Thermal Resistance-Junction to Lead    | Steady State         | 20         |      |
| I <sub>AS</sub> <sup>b</sup> | Avalanche Current, Single pulse        | L=0.1mH              | 23         | A    |
| E <sub>AS</sub> <sup>b</sup> | Avalanche Energy, Single pulse         | L=0.1mH              | 26         | mJ   |

Note a : Max. current is limited by bonding wire.

Note b : UIS tested and pulse width limited by maximum junction temperature  $150^\circ\text{C}$  (initial temperature  $T_J=25^\circ\text{C}$ ).

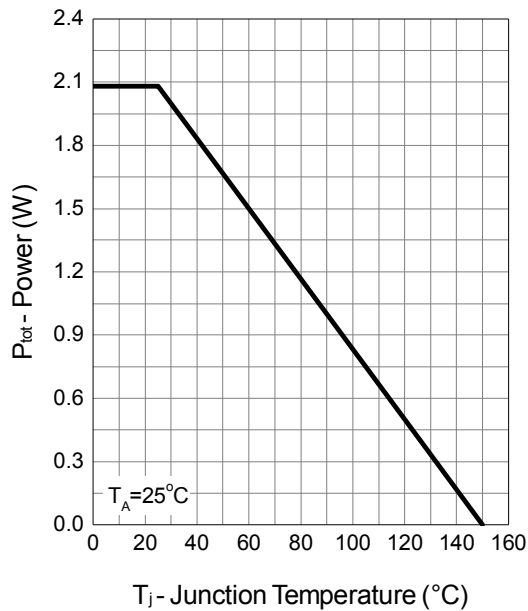
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

| Symbol                                   | Parameter                        | Test Conditions                                                                                                 | Min. | Typ.  | Max. | Unit |
|------------------------------------------|----------------------------------|-----------------------------------------------------------------------------------------------------------------|------|-------|------|------|
| Static Characteristics                   |                                  |                                                                                                                 |      |       |      |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage   | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA                                                                     | 40   | -     | -    | V    |
| I <sub>DSS</sub>                         | Zero Gate Voltage Drain Current  | V <sub>DS</sub> =32V, V <sub>GS</sub> =0V                                                                       | -    | -     | 1    | μA   |
|                                          |                                  | T <sub>J</sub> =85°C                                                                                            | -    | -     | 30   |      |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage           | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA                                                       | 1.5  | 1.8   | 2.5  | V    |
| I <sub>GSS</sub>                         | Gate Leakage Current             | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                                                      | -    | -     | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>c</sup>         | Drain-Source On-state Resistance | V <sub>GS</sub> =10V, I <sub>DS</sub> =7A                                                                       | -    | 8.5   | 10.5 | mΩ   |
|                                          |                                  | T <sub>J</sub> =125°C                                                                                           | -    | 12.75 | -    |      |
|                                          |                                  | V <sub>GS</sub> =4.5V, I <sub>DS</sub> =5A                                                                      | -    | 10    | 12.5 |      |
| Gfs                                      | Forward Transconductance         | V <sub>DS</sub> =5V, I <sub>DS</sub> =15A                                                                       | -    | 30    | -    | S    |
| Diode Characteristics                    |                                  |                                                                                                                 |      |       |      |      |
| V <sub>SD</sub> <sup>c</sup>             | Diode Forward Voltage            | I <sub>SD</sub> =10A, V <sub>GS</sub> =0V                                                                       | -    | 0.9   | 1.1  | V    |
| t <sub>rr</sub>                          | Reverse Recovery Time            | V <sub>DD</sub> =20V,<br>I <sub>SD</sub> =10A, dI <sub>SD</sub> /dt=100A/μs                                     | -    | 16.2  | -    | ns   |
| t <sub>a</sub>                           | Charge Time                      |                                                                                                                 | -    | 9.4   | -    |      |
| t <sub>b</sub>                           | Discharge Time                   |                                                                                                                 | -    | 6.8   | -    |      |
| Q <sub>rr</sub>                          | Reverse Recovery Charge          |                                                                                                                 | -    | 9.8   | -    | nC   |
| Dynamic Characteristics <sup>d</sup>     |                                  |                                                                                                                 |      |       |      |      |
| R <sub>G</sub>                           | Gate Resistance                  | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz                                                                | 0.7  | 1.1   | 1.8  | Ω    |
| C <sub>iss</sub>                         | Input Capacitance                | V <sub>GS</sub> =0V,<br>V <sub>DS</sub> =20V,<br>Frequency=1.0MHz                                               | -    | 1325  | -    | pF   |
| C <sub>oss</sub>                         | Output Capacitance               |                                                                                                                 | -    | 142   | -    |      |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance     |                                                                                                                 | -    | 90    | -    |      |
| t <sub>d(ON)</sub>                       | Turn-on Delay Time               | V <sub>DD</sub> =20V, R <sub>L</sub> =20Ω,<br>I <sub>DS</sub> =1A, V <sub>GEN</sub> =10V,<br>R <sub>G</sub> =1Ω | -    | 14.6  | -    | ns   |
| t <sub>r</sub>                           | Turn-on Rise Time                |                                                                                                                 | -    | 12    | -    |      |
| t <sub>d(OFF)</sub>                      | Turn-off Delay Time              |                                                                                                                 | -    | 24.6  | -    |      |
| t <sub>f</sub>                           | Turn-off Fall Time               |                                                                                                                 | -    | 8     | -    |      |
| Gate Charge Characteristics <sup>d</sup> |                                  |                                                                                                                 |      |       |      |      |
| Q <sub>g</sub>                           | Total Gate Charge                | V <sub>DS</sub> =20V, V <sub>GS</sub> =4.5V,<br>I <sub>DS</sub> =7A                                             | -    | 9.9   | -    | nC   |
| Q <sub>g</sub>                           | Total Gate Charge                | V <sub>DS</sub> =20V, V <sub>GS</sub> =10V,<br>I <sub>DS</sub> =7A                                              | -    | 21    | 28   |      |
| Q <sub>gth</sub>                         | Threshold Gate Charge            |                                                                                                                 | -    | 2     | -    |      |
| Q <sub>gs</sub>                          | Gate-Source Charge               |                                                                                                                 | -    | 4.9   | -    |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge                |                                                                                                                 | -    | 5     | -    |      |

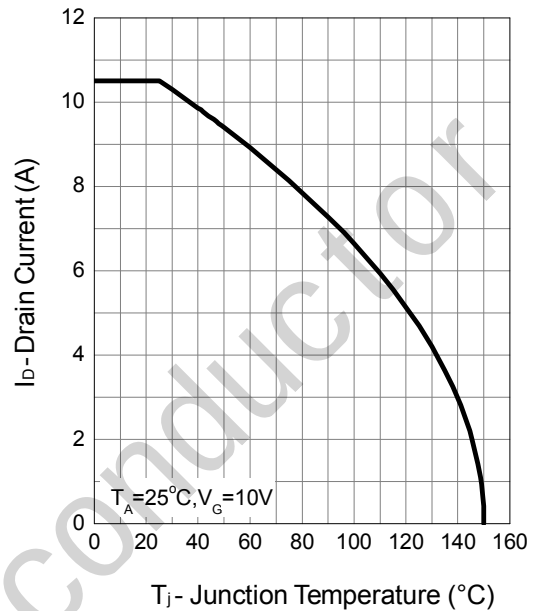
Note c : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

## Typical Operating Characteristics

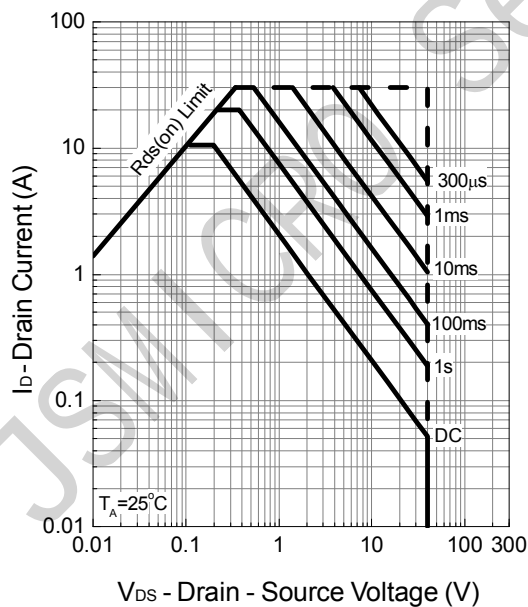
Power Dissipation



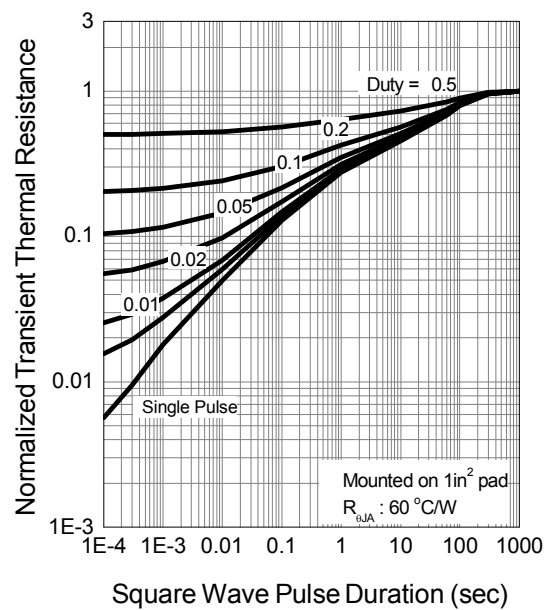
Drain Current



Safe Operation Area

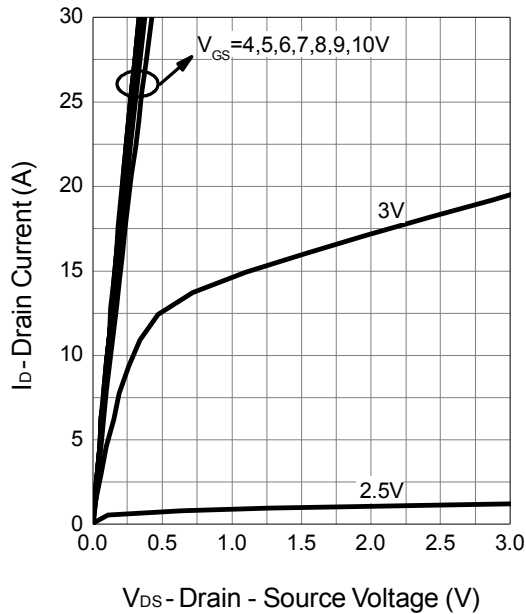


Thermal Transient Impedance

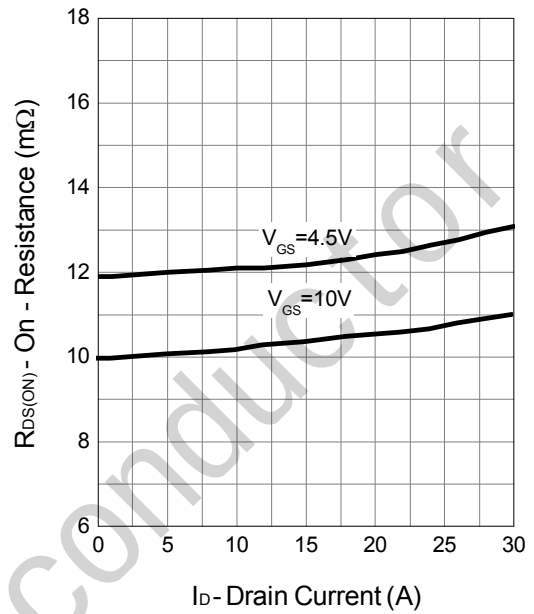


## Typical Operating Characteristics (Cont.)

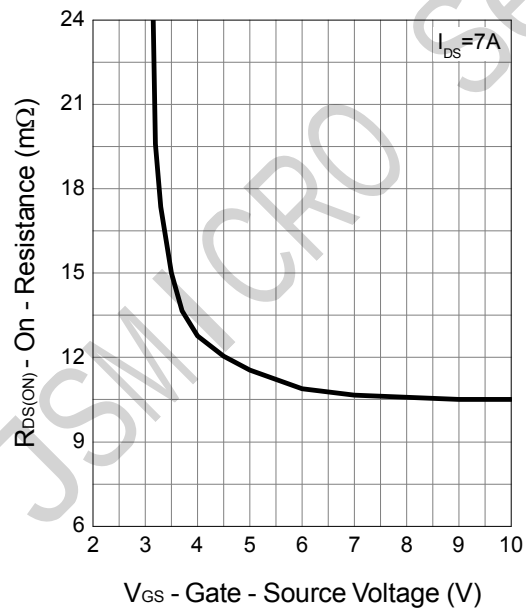
Output Characteristics



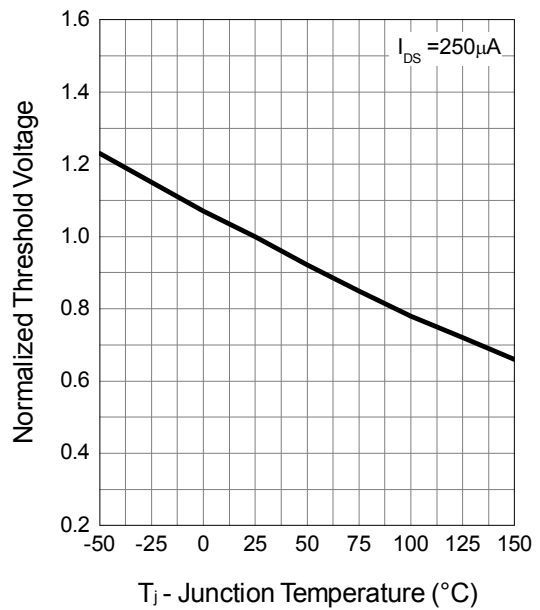
Drain-Source On Resistance



Gate-Source On Resistance

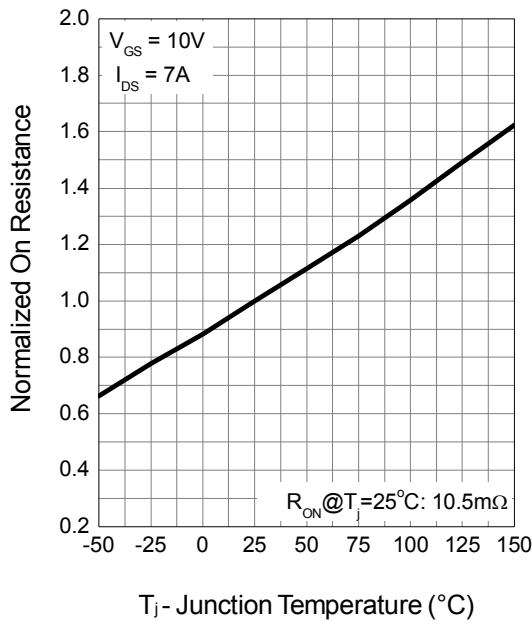


Gate Threshold Voltage

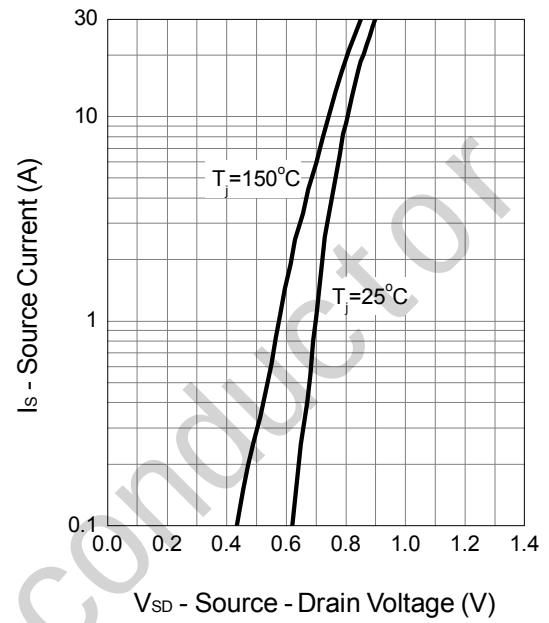


## Typical Operating Characteristics (Cont.)

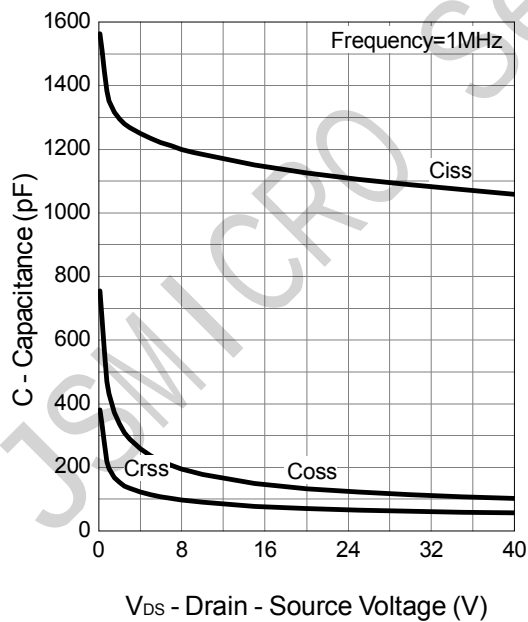
Drain-Source On Resistance



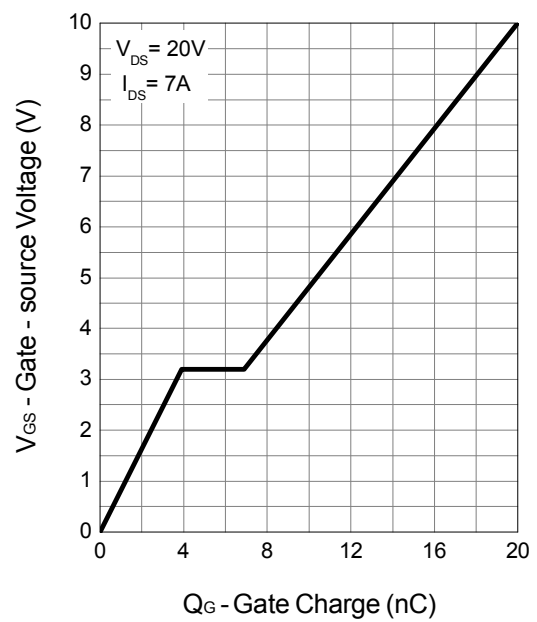
Source-Drain Diode Forward



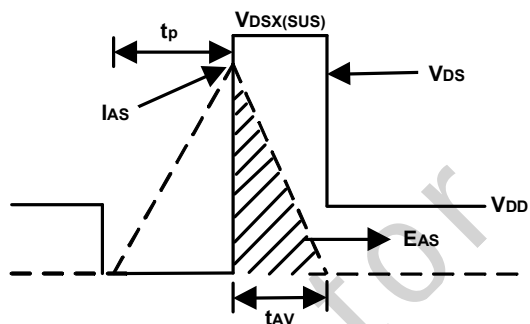
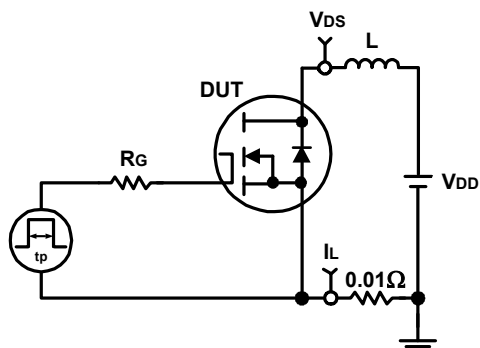
Capacitance



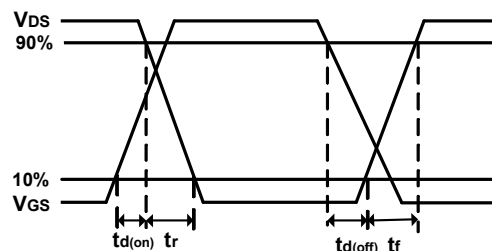
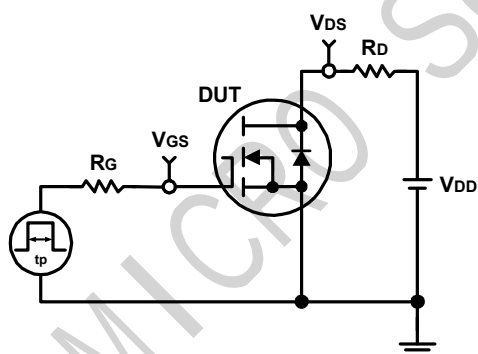
Gate Charge



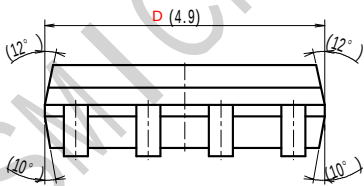
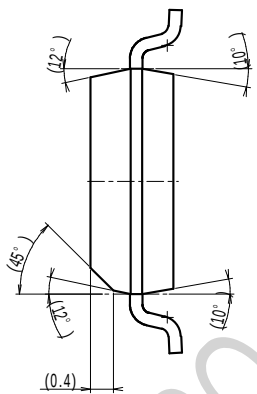
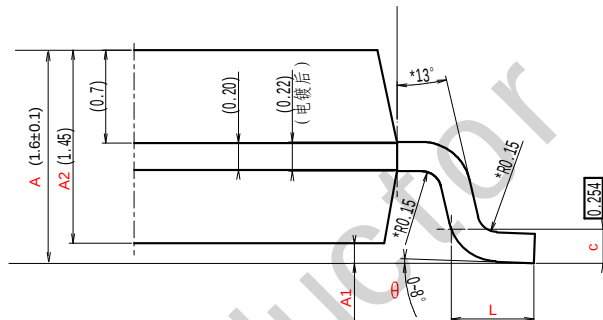
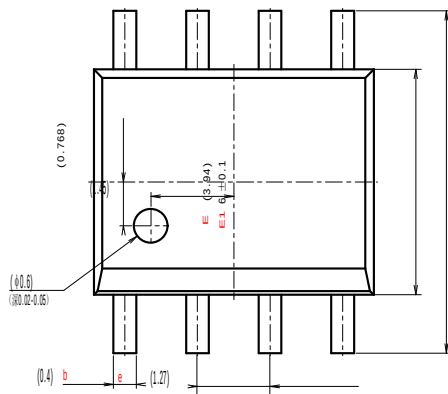
## Avalanche Test Circuit and Waveforms



## Switching Time Test Circuit and Waveforms



## SOP8 PACKAGE OUTLINE



| 字符 | Dimension millimeters |            |       |
|----|-----------------------|------------|-------|
|    | Min                   | Standard   | Max   |
| A  | 1.500                 | 1.600      | 1.700 |
| A1 | 0.040                 | 0.080      | 0.150 |
| A2 | 1.350                 | 1.450      | 1.550 |
| b  | 0.300                 | 0.400      | 0.500 |
| c  | 0.220                 | 0.254      | 0.280 |
| D  | 4.800                 | 4.900      | 5.000 |
| E  | 3.840                 | 3.940      | 4.040 |
| E1 | 5.900                 | 6.000      | 6.100 |
| e  |                       | 1.27 (BSC) |       |
| L  | 0.400                 | 0.550      | 0.700 |
| θ  | 0°                    |            | 8°    |